TOSHIBA Power Module Silicon N Channel IGBT

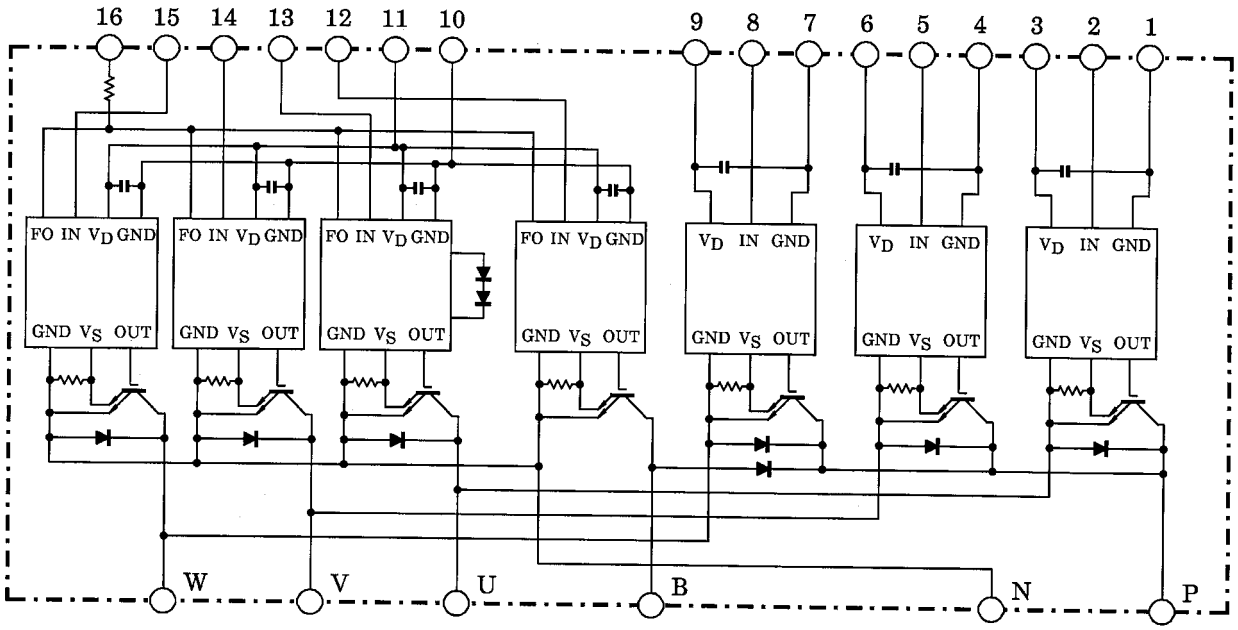
MIG100J201HC

High Power Switching Applications

Motor Control Applications

- Integrates inverter, brake power circuits & control circuits (IGBT drive units, protection units for over-current, under-voltage & over-temperature) in one package.
- The electrodes are isolated from case.
- High speed type IGBT : $V_{CE\ (sat)}$ = 2.8 V (Max.)
  t_{off} = 3.0 μs (Max.)
  t_{rr} = 0.30 μs (Max.)
- Outline : TOSHIBA 2-110A1A
- Weight : 520 g

Equivalent Circuit



1. GND (U)	2. IN (U)	3. V_D (U)	4. GND (V)	5. IN (V)	6. V_D (V)
7. GND (W)	8. IN (W)	9. V_D (W)	10.GND (L)	11.V_D (L)	12.IN (B)
13.IN (X)	14.IN (Y)	15.IN (Z)	16.FO		

Maximum Ratings (T_j = 25°C)

Stage	Characteristic	Condition	Symbol	Ratings	Unit
Inverter	Supply voltage	P-N power terminal	V_{CC}	450	V
	Collector-emitter voltage	—	V_{CES}	600	V
	Collector current	T_c = 25°C, DC	I_C	100	A
	Forward current	T_c = 25°C, DC	I_F	100	A
	Collector power dissipation	T_c = 25°C	P_C	300	W
	Junction temperature	—	T_j	150	°C
Brake	Supply voltage	P-N power terminal	V_{CC}	450	V
	Collector-emitter voltage	—	V_{CES}	600	V
	Collector current	T_c = 25°C, DC	I_C	30	A
	Reverse voltage	—	V_R	600	V
	Forward current	T_c = 25°C, DC	I_F	30	A
	Collector power dissipation	T_c = 25°C	P_C	80	W
	Junction temperature	—	T_j	150	°C
Control	Control supply voltage	V_D-GND terminal	V_D	20	V
	Input voltage	IN-GND terminal	V_{IN}	20	V
	Fault output voltage	FO-GND (L) terminal	V_{FO}	20	V
	Fault output current	FO sink current	I_{FO}	14	mA
Module	Operating temperature	—	TC	−20 ~ +100	°C
	Storage temperature range	—	T_{stg}	−40 ~ +125	°C
	Isolation voltage	AC 1 minute	V_{ISO}	2500	V
	Screw torque	M5	—	3	N·m

Electrical Characteristics (T_j = 25°C)

a. Inverter Stage

Characteristic	Symbol	Test Condition		Min	Typ.	Max	Unit
Collector cut-off current	I_{CEX}	V_{CE} = 600 V	T_j = 25°C	—	—	1	mA
			T_j = 125°C	—	—	20	
Collector-emitter saturation voltage	$V_{CE\ (sat)}$	V_D = 15 V, I_C = 100 A V_{IN} = 15 V → 0 V	T_j = 25°C	—	2.3	2.8	V
			T_j = 125°C	—	2.3	—	
Forward voltage	V_F	I_F = 100 A		—	2.1	3.3	V
Switching time	t_{on}	V_{CC} = 300 V, I_C = 100 A V_D = 15 V, V_{IN} = 15 V ↔ 0 V Inductive load (Note 1)		—	1.0	2.0	μs
	t_{off}			—	1.7	3.0	
	t_f			—	0.2	0.5	
	t_{rr}			—	0.1	0.3	

b. Brake Stage

Characteristic	Symbol	Test Condition		Min	Typ.	Max	Unit
Cellector cut-off current	I_{CEX}	V_{CEX} = 600V	T_j = 25°C	—	—	1	mA
			T_j = 125°C	—	—	20	
Collector-emitter saturation voltage	$V_{CE\ (sat)}$	V_D = 15V, I_C = 30A V_{IN} = 15V→0V	T_j = 25°C	—	1.7	2.7	V
			T_j = 125°C	—	1.6	—	
Reverse current	I_R	V_R=600V	T_j = 25°C	—	—	1	mA
			T_j = 125°C	—	—	20	
Forward voltage	V_F	I_F = 30A		—	2.0	2.5	V
Switching time	t_{on}	V_{CC} = 300V, I_C = 30A V_D = 15V, V_{IN} = 15V↔0V Inductive load (Note 1)		—	0.9	2.0	μs
	t_{off}			—	1.7	3.0	
	t_f			—	0.25	0.5	
	t_{rr}			—	0.15	0.3	

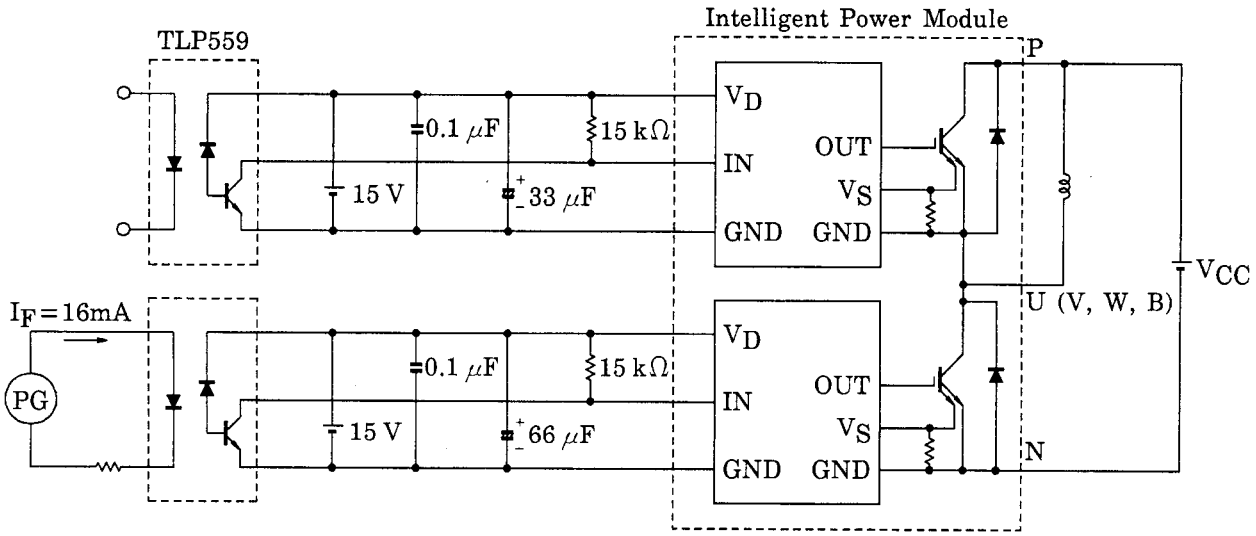
c. Control Stage (T_j = 25°C)

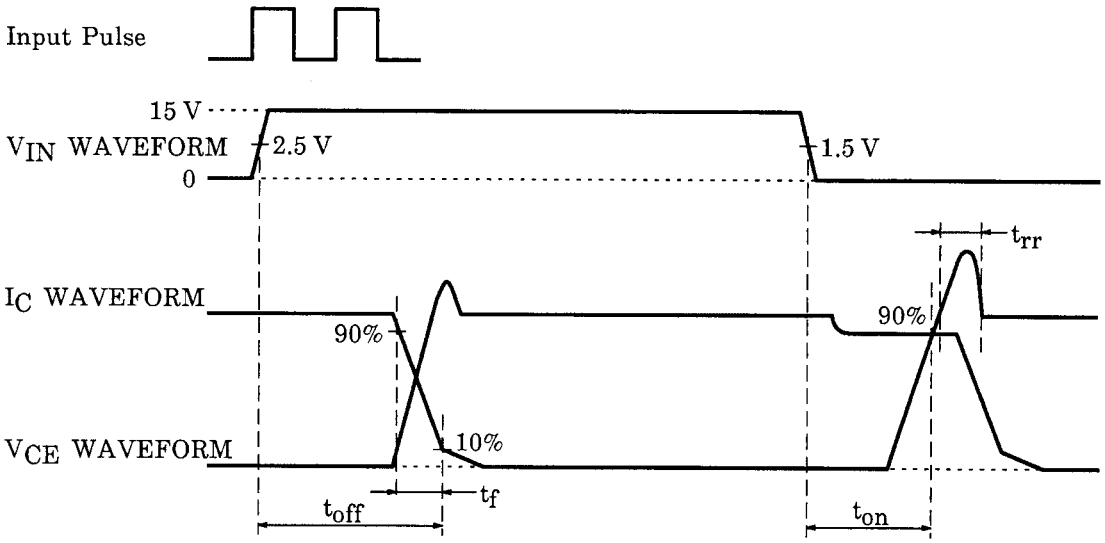
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Control circuit current	High side	$I_{D\ (H)}$	V_D = 15 V	—	8	—	mA
	Low side	$I_{D\ (L)}$		—	35	—	
Input-on signal voltage		$V_{IN\ (on)}$	V_D = 15 V, I_C = 100 mA	1.3	1.5	1.7	V
Input-off signal voltage		$V_{IN\ (off)}$	V_D = 15 V, I_C = 100 mA	2.2	2.5	2.8	V
Fault output current	Protection	$I_{FO\ (on)}$	V_D = 15 V	8	10	12	mA
	Normal	$I_{FO\ (off)}$		—	—	1	
Over current protection trip level	Inverter	OC	V_D = 15 V, T_j = 125°C	160	200	—	A
	Brake			40	—	—	
Short current protection trip level	Trip level	SC	V_D = 15 V, T_j = 125°C	240	300	—	A
	Reset level			60	—	—	
Over current cut-off time		$t_{off\ (OC)}$	V_D = 15 V	—	5	—	μs
Over temperature protection	Trip level	OT	Case temperature	110	118	125	°C
	Reset level	OTr		—	80	—	
Control supply under voltage protection	Trip level	UV	—	11.0	12.0	12.5	V
	Reset level	UVr		—	12.5	—	
Fault output pulse width		t_{FO}	V_D = 15 V	1	2	3	ms

d. Thermal Resistance (T_j = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Junction to case thermal resistance	$R_{th\ (j\text{-}c)}$	Inverter IGBT stage	—	—	0.418	°C / W
		Inverter FRD stage	—	—	1.000	
		Brake IGBTstage	—	—	1.562	
		Brake FRD stage	—	—	2.000	
Case to fin thermal resistance	$R_{th\ (c\text{-}f)}$	Compound is applied	—	0.05	—	°C / W

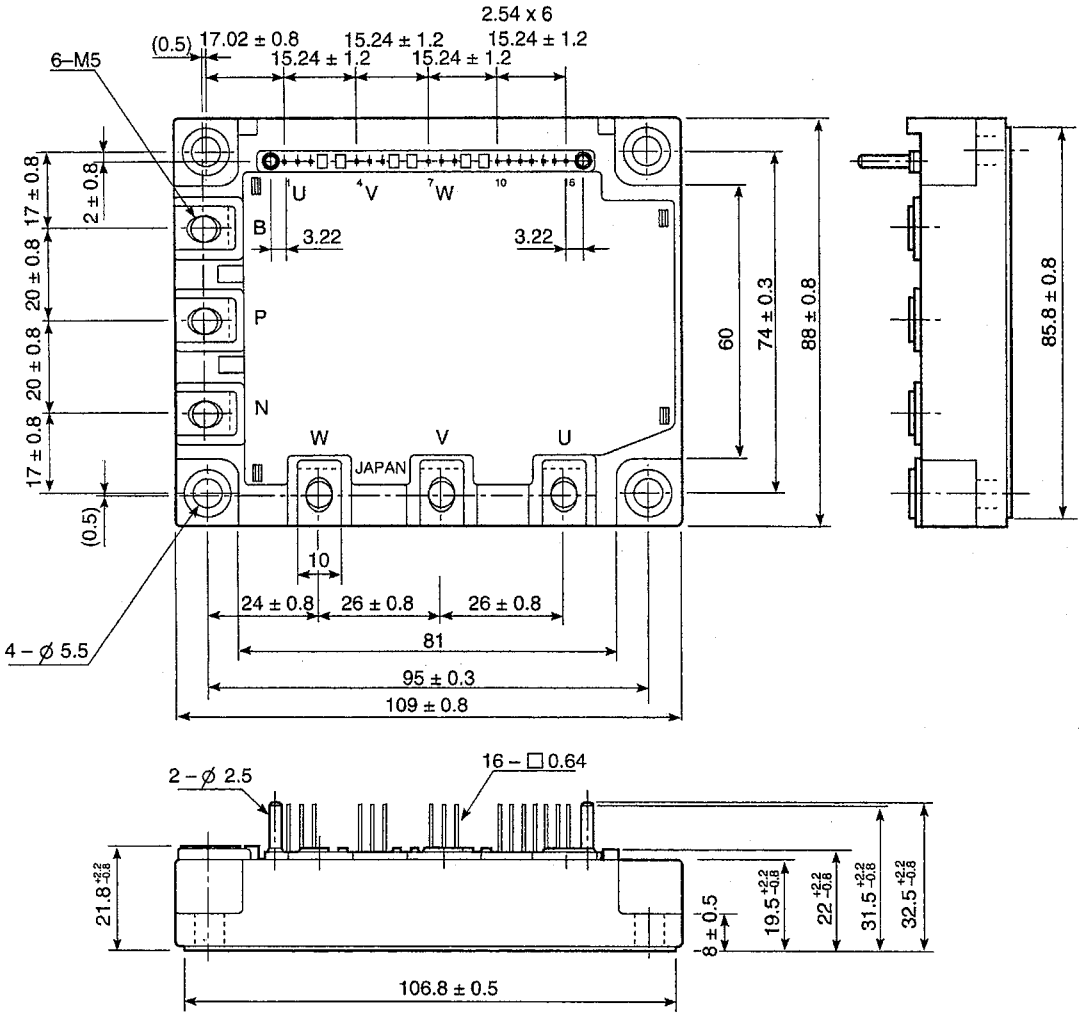
Note 1: Switching time test circuit & timing chart

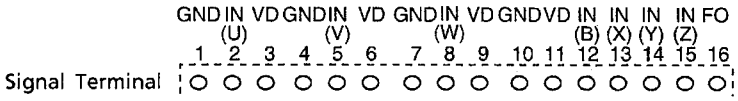




Package Dimensions: TOSHIBA 2-110A1A

Unit: mm





RESTRICTIONS ON PRODUCT USE

000707EAA

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the “Handling Guide for Semiconductor Devices,” or “TOSHIBA Semiconductor Reliability Handbook” etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury (“Unintended Usage”). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer’s own risk.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.